SN5454, SN54LS54, SN7454, SN74LS54 **4-WIDE AND-OR-INVERT GATES**

SDLS115

DECEMBER 1983-REVISED MARCH 1988

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	DECEMBER 1983-HEVISED I
 Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs 	SN5454 J PACKAGE SN7454 N PACKAGE (TOP VIEW) A
 Dependable Texas Instruments Quality and Reliability 	C [] 2 13]] B D [] 3 12] NU E [] 4 11] NU
description	F☐5 10☐H NC☐6 9☐G
These devices contain 4-wide AND-OR-INVERT gates. They perform the following Boolean functions:	NC 6 9 G GND 7 8 Y
$\begin{array}{rcl} 54 & Y &=& \overline{AB + CD + EF + GH} \\ LS54 & Y &=& \overline{AB + CDE + FGH + IJ} \end{array}$	SN5454 W PACKAGE (TOP VIEW)
The SN5454 and SN54LS54 are characterized for	
operation over the full military temperature range of - 55 °C to 125 °C. The SN7454 and SN74LS54 are	
characterized for operation from 0°C to 70°C.	A []3 12] Y V _{CC} []4 11] GND
logic diagrams (positive logic)	⊂⊈e a⊒F
′ 5 4	DQ <u>7</u> 8₽E
	SN54LS54 J OR W PACKAGE SN74LS54 D OR N PACKAGE
c	
	B□[2 13]] J C□[3 12]
	рД₄ ирн
	Y 6 9 F GND 7 8 NC
A	SN54LS54 FK PACKAGE (TOP VIEW)
	NC[5 17]NC
	NC]7 15[]NC E]8 14[]G
	9 10 11 12 13
	× Q N N N
	ଞ
	NC—No internal connection NU—Make no external connection
PRODUCTION DATA documents contain information current as of publication date. Products conform to	
current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters. POST OFFICE BOX 655012 • DALLAS. TEXA	AS 75265

SN5454, SN54LS54, SN7454, SN74LS54 4-WIDE AND-OR-INVERT GATES



[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N package. For the SN54LS54 only, they apply also for the W package.

schematics



Resistor values shown are nominal.

The portion of the circuits within the dashed lines is repeated for each additional 2- or 3-input AND section, as shown in the logic diagram and logic symbols.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage	
Operating free-air temperature: SN5454	
SN7454	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5454			SN7454			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH High-level input voltage	2			2			V	
VIL Low-level input voitage			0.8	_		0.8	V .	
OH High-level output current			- 0.4		_	- 0.4	mΑ	
IOL Low-level output current			16			16	mΑ	
TA Operating free-air temperature	- 55		125	0		70	°C	

electrical characterics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS!			SN5454			SN7454	t	UNIT
PARAMETER		TEST CONDITIONS [†]	MIN	TYP‡	MAX	MIN	TYP‡	MAX		
VIK	V _{CC} = MIN.	lj = 12 mA				- 1.5	[- 1.5	V
∨он	VCC = MIN,	V _{IL} = 0.8 V,	l _{QH} = - 0.4 mA	2.4	3.4		2.4	3.4		V
VOL	V _{CC} = MIN.	V _{1H} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	V
- Ij	V _{CC} = MAX,	Vi = 5.5 V				1			1	mA
Чн	V _{CC} = MAX,	V ₁ = 2.4 V				40	Γ		40	μA
IIL.	V _{CC} = MAX,	Vi = 0.4 V				- 1.6			- 1.6	mA
losŝ	V _{CC} = MAX			20		- 55	- 18		- 55	mΑ
ICCH	VCC = MAX,	V = 0 V			4	8		4	8	mA
ICCL	V _{CC} = MAX,	See Note 2			5.1	9.5		5.1	9.5	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

SNot more than one output should be shorted at a time.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 3)

PARAMETER	FROM (INPUT)	ТО (OUTPUT)	TEST CONDITIONS	MIN	түр	мах	UNIT
^t PLH	A	, , , , , , , , , , , , , , , , , , ,	$R_1 = 400 \Omega_2$ $C_1 = 15 pF$		13	22	ns
^t PHL	Апу	ſ	R _L = 400 Ω, C _L = 15 pF		8	15	ns –

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN54LS54, SN74LS54 4-WIDE AND-OR-INVERT GATES

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note	9 1)	v
Input voltage		v
Operating free-air temperature:	SN54LS54	С
	SN74LS54 0°C to 70°C	С
Storage temperature range		с

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		s	SN54LS54			SN74LS54			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.7			0.8	V	
юн	High-level output current			- 0.4			- 0.4	mA	
OL	Low-level output current			4			8	mΑ	
τ _A	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]		S	N54LS	i4	S	N74LS	54		
	1				TYP‡	MAX	MIN	TYP ±	MAX	UNIT
VIK	Vcc = MIN,	lj = 18 mA				- 1.5			- 1.5	V
Voн	V _{CC} = MIN,	V _{IL} = MAX,	OH = - 0.4 mA	2.5	3.4		2.7	3.4		l v
VOL	V _{CC} ≈ MIN,	V _{1H} = 2 V,	OL=4mA		0.25	0.4		0.25	0.4	
	V _{CC} = MIN	V _{IH} = 2 V,	OL = 8 mA					0.35	0.5	l V
41	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
ч <u>н</u>	V _{CC} = MAX,	V1 = 2.7 V				20			20	μA
<u> </u>	V _{CC} = MAX,	V = 0.4 V			-	- 0.4			- 0.4	mA
lOS§	V _{CC} = MAX			- 20		- 100	- 20		- 100	mA
ССН	V _{CC} = MAX,	Vj = 0 V			0.8	1.6		0.8	1.6	mΑ
ICCL	V _{CC} = MAX,	See Note 2			1	2	<u> </u>	1	2	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25° C.

§Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

switching characteristics, V_{CC} = 5 V, T_A = 25° C (see note 3)

PARAMETER	FROM (INPUT)	то (оитрит)	TEST CONDITIONS	MIN T	TYP	MAX	UNIT
t P L H	Any	v	$R_1 = 2 k\Omega, \qquad C_1 = 15 pF$		12	20	กร
^t PHL		·		1	2.5	20	ពន

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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